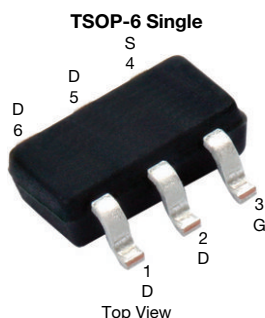


## P-Channel 20 V (D-S) MOSFET


**Marking Code:** 25

PRODUCT SUMMARY	
$V_{DS}$ (V)	-20
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10$ V	0.028
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5$ V	0.035
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -2.5$ V	0.052
$Q_g$ typ. (nC)	7.0
$I_D$ (A) <sup>a</sup>	-8
Configuration	Single

ORDERING INFORMATION	
Package	TSOP-6
Lead (Pb)-free and halogen-free	Si3425DV-T1-GE3

ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	$V_{DS}$	-20	V	
Gate-source voltage	$V_{GS}$	$\pm 12$		
Continuous drain current ( $T_J = 150^\circ\text{C}$ ) <sup>a</sup>	$T_F = 25^\circ\text{C}$	-8	A	
	$T_F = 70^\circ\text{C}$	-6.8 <sup>a</sup>		
	$T_A = 25^\circ\text{C}$	-6.9 <sup>b, c</sup>		
	$T_A = 70^\circ\text{C}$	-5.5 <sup>b, c</sup>		
Pulsed drain current ( $V_{GS} = 10$ V, $t = 100$ $\mu\text{s}$ )	$I_{DM}$	-30		
Continuous source-drain diode current	$T_F = 25^\circ\text{C}$	-2.7	A	
	$T_A = 25^\circ\text{C}$	-1.8 <sup>b, c</sup>		
Maximum power dissipation <sup>a</sup>	$T_F = 25^\circ\text{C}$	3.0	W	
	$T_F = 70^\circ\text{C}$	2.8		
	$T_A = 25^\circ\text{C}$	2 <sup>b, c</sup>		
	$T_A = 70^\circ\text{C}$	1.3 <sup>b, c</sup>		
Operating junction and storage temperature range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient <sup>b, d</sup>	$t \leq 5$ s	$R_{thJA}$	52	62.5	$^\circ\text{C/W}$
Maximum junction-to-foot (drain)	Steady state	$R_{thJF}$	34	41	

**Notes**

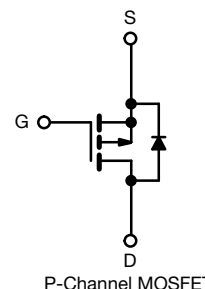
- Package limited
- Surface mounted on 1" x 1" FR4 board
- $t = 5$  s
- Maximum under steady state conditions is 110  $^\circ\text{C/W}$

**FEATURES**

- TrenchFET<sup>®</sup> gen V p-channel MOSFET
- 100 %  $R_g$  and UIS tested
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)

**APPLICATIONS**

- Load switches
- DC/DC converters
- Power management
- LED backlighting


**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**


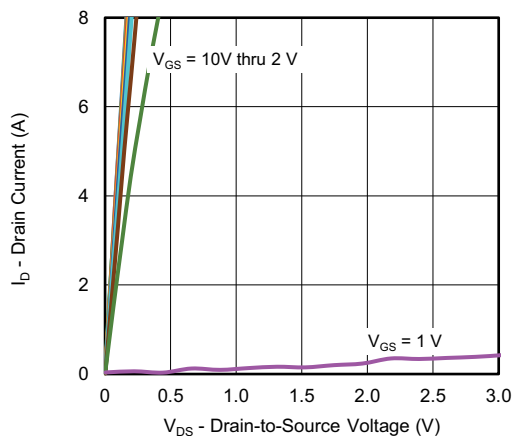
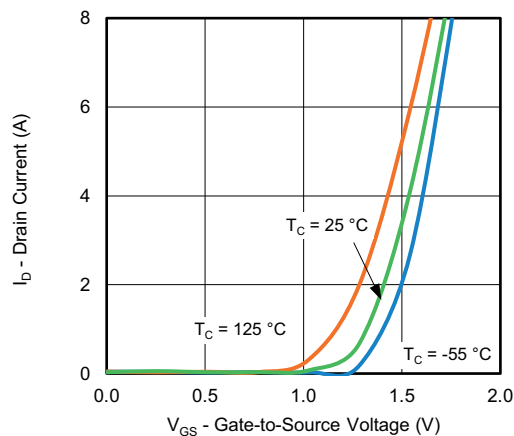
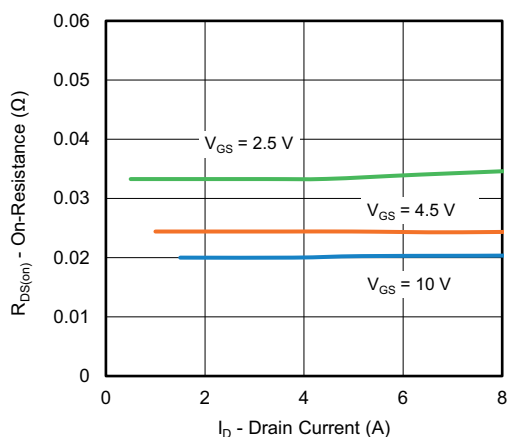
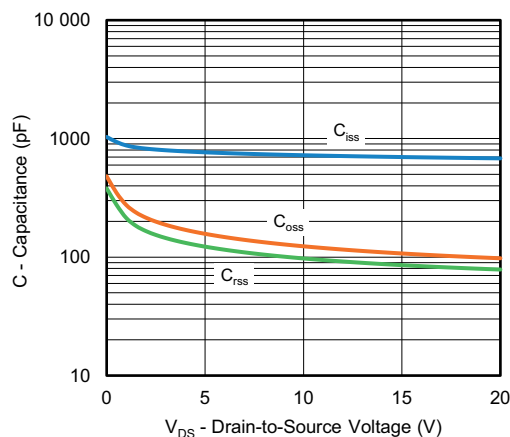
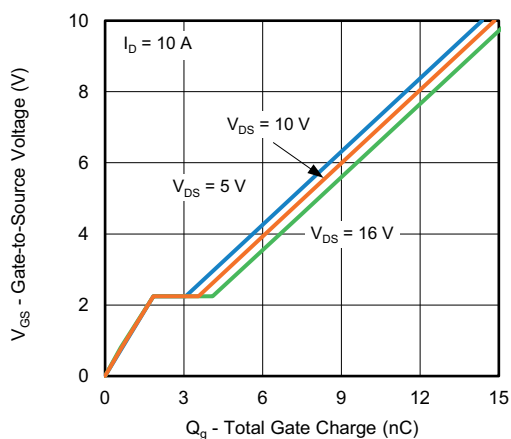
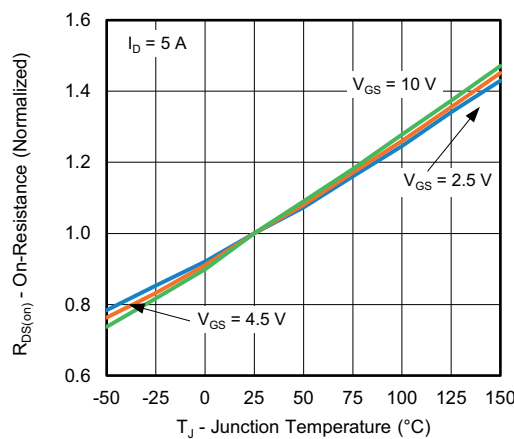


SPECIFICATIONS (T <sub>J</sub> = 25 °C, unless otherwise noted)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = -250 μA	-20	-	-	V	
V <sub>DS</sub> temperature coefficient	ΔV <sub>DS</sub> /T <sub>J</sub>	I <sub>D</sub> = -10 mA	-	-14.2	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	ΔV <sub>GS(th)</sub> /T <sub>J</sub>	I <sub>D</sub> = -250 μA	-	3.2	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = -250 μA	-0.6	-	-1.5	V	
Gate-source leakage	I <sub>GSS</sub>	V <sub>DS</sub> = 0 V, V <sub>GS</sub> = ± 12 V	-	-	± 100	nA	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V	-	-	-1	μA	
		V <sub>DS</sub> = -20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-10		
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -5 A	-	0.021	0.028	Ω	
		V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -3 A	-	0.0255	0.035		
		V <sub>GS</sub> = -2.5 V, I <sub>D</sub> = -2 A	-	0.035	0.052		
Forward transconductance	g <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -6 A	-	20	-	S	
Dynamic <sup>b</sup>							
Input capacitance	C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	730	-	pF	
Output capacitance	C <sub>oss</sub>		-	125	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	100	-		
Total gate charge	Q <sub>g</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 10 V, I <sub>D</sub> = -10 A	-	15	23	nC	
Gate-source charge	Q <sub>gs</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 10 A	-	7	11		
Gate-drain charge	Q <sub>gd</sub>		-	1.8	-		
Gate resistance	R <sub>g</sub>		-	1.8	-		
Turn-on delay time	t <sub>d(on)</sub>	f = 1 MHz	1.3	6.5	13	Ω	
Rise time	t <sub>r</sub>		V <sub>DD</sub> = -10 V, R <sub>L</sub> = 1 Ω I <sub>D</sub> ≅ -10 A, V <sub>GEN</sub> = -4.5 V, R <sub>g</sub> = 1 Ω	-	12	25	ns
Turn-off delay time	t <sub>d(off)</sub>			-	32	65	
Fall time	t <sub>f</sub>			-	22	45	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = -10 V, R <sub>L</sub> = 1 Ω I <sub>D</sub> ≅ -10 A, V <sub>GEN</sub> = -10 V, R <sub>g</sub> = 1 Ω		-	10	20	
Rise time	t <sub>r</sub>		-	7	15		
Turn-off delay time	t <sub>d(off)</sub>		-	5	10		
Fall time	t <sub>f</sub>		-	19	40		
Drain-Source Body Diode Characteristics							
Continous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-2.7	A	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	-30		
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -5 A, V <sub>GS</sub> = 0 V	-	-0.81	-1.1	V	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -10 A, dI/dt = 100 A/μs, T <sub>J</sub> = 25 °C	-	2.5	5	nC	
Body diode reverse recovery time	t <sub>rr</sub>		-	8	20	ns	
Reverse recovery fall time	t <sub>a</sub>		-	5	-		
Reverse recovery rise time	t <sub>b</sub>		-	3	-		

**Notes**

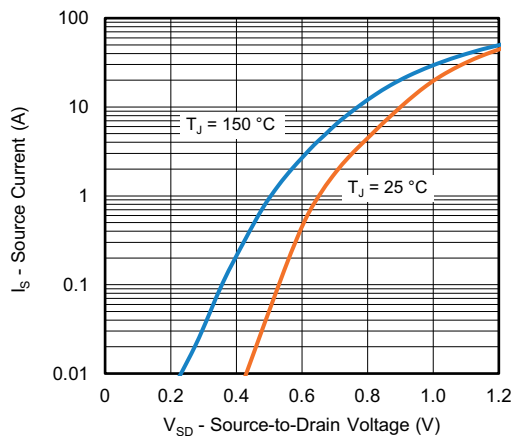
- a. Pulse test; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$   
b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

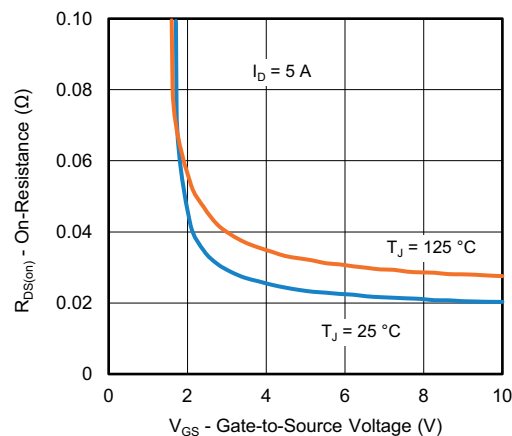
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)

**Output Characteristics**

**Transfer Characteristics Curves vs. Temperature**

**On-Resistance vs. Drain Current**

**Capacitance**

**Gate Charge**

**On-Resistance vs. Junction Temperature**



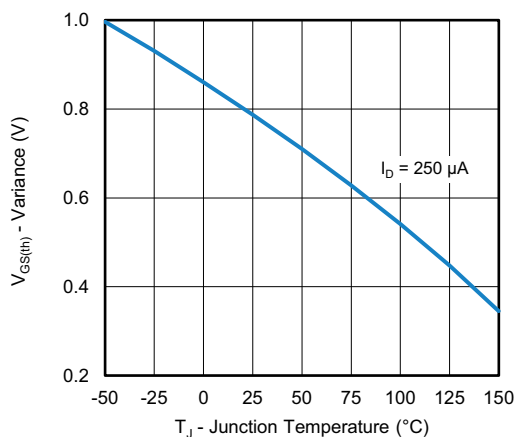
**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)



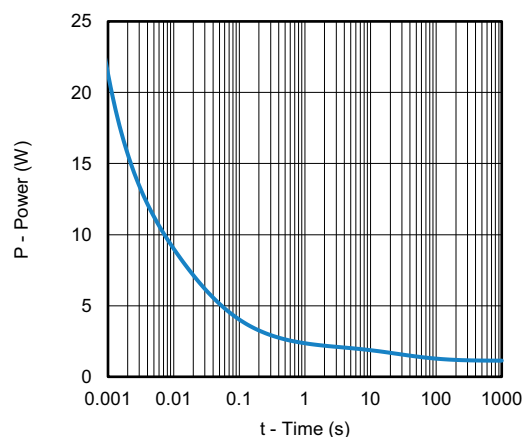
Source-Drain Diode Forward Voltage



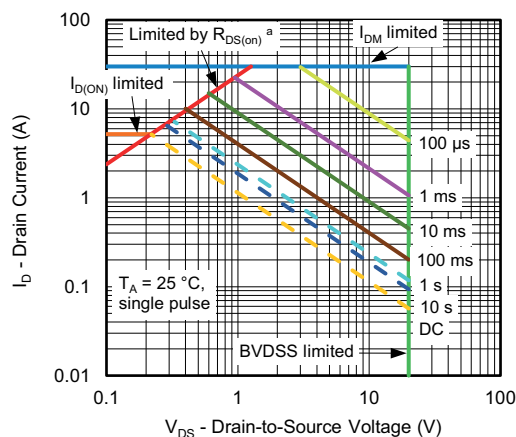
$R_{DS(on)}$  vs.  $V_{GS}$  vs. Temperature



Threshold Voltage



Single Pulse Power



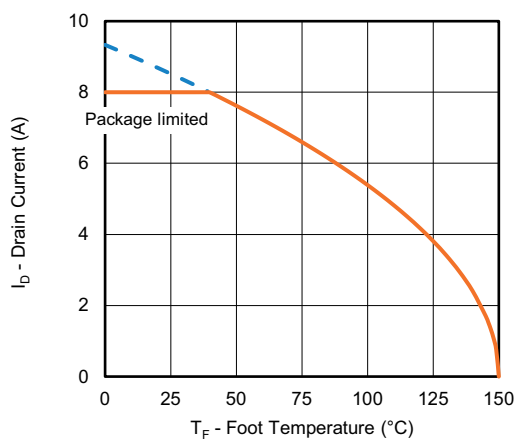
Safe Operating Area, Junction-to-Ambient

**Note**

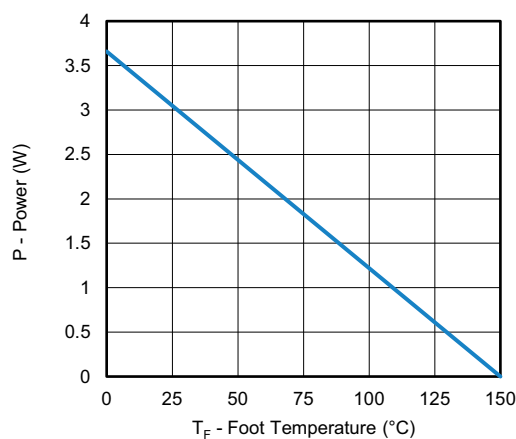
a.  $V_{GS} >$  minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified



**TYPICAL CHARACTERISTICS** ( $T_A = 25^\circ\text{C}$ , unless otherwise noted)



**Current Derating <sup>a</sup>**



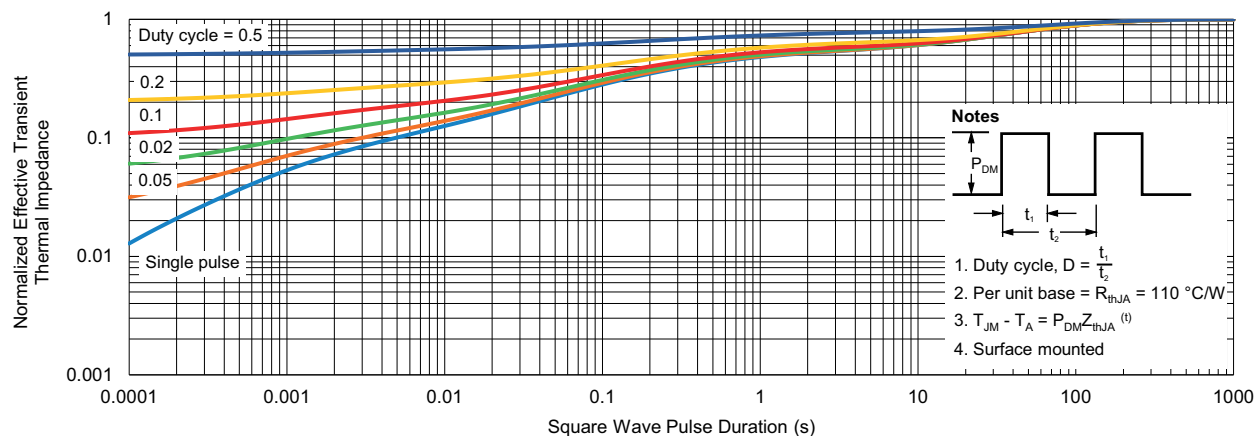
**Power, Junction-to-Foot**

**Note**

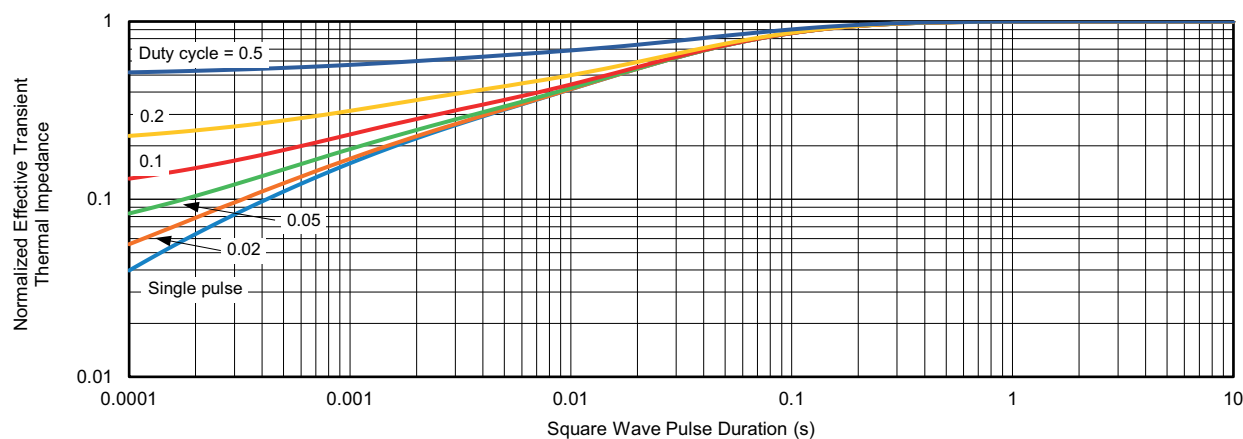
- a. The power dissipation  $P_D$  is based on  $T_J$  max. =  $150^\circ\text{C}$ , using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



**TYPICAL CHARACTERISTICS** ( $T_A = 25\text{ }^{\circ}\text{C}$ , unless otherwise noted)



**Normalized Thermal Transient Impedance, Junction-to-Ambient**



**Normalized Thermal Transient Impedance, Junction-to-Foot**

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## TSOP: 5/6-LEAD

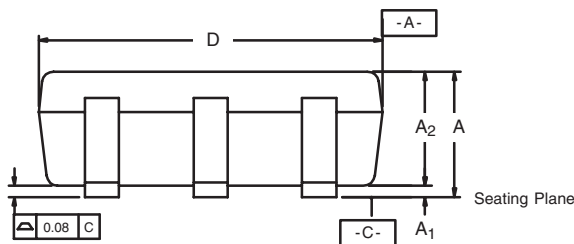
JEDEC Part Number: MO-193C



5-LEAD TSOP

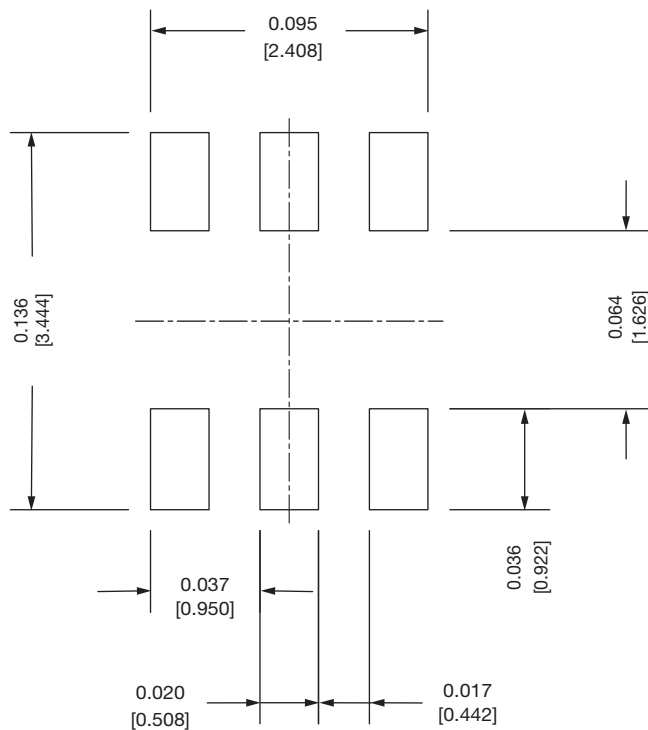
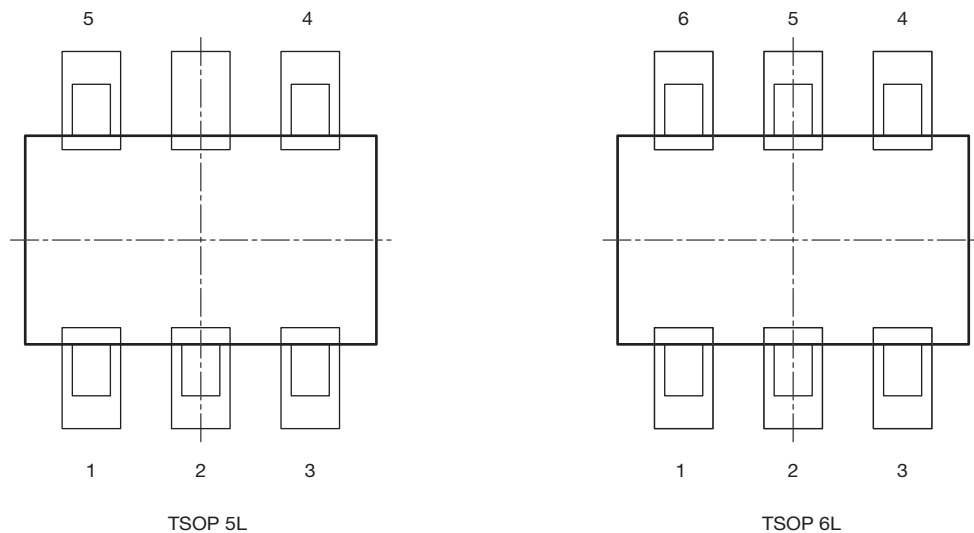


6-LEAD TSOP



Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.91	-	1.10	0.036	-	0.043
A <sub>1</sub>	0.01	-	0.10	0.0004	-	0.004
A <sub>2</sub>	0.90	-	1.00	0.035	0.038	0.039
b	0.30	0.32	0.45	0.012	0.013	0.018
c	0.10	0.15	0.20	0.004	0.006	0.008
D	2.95	3.05	3.10	0.116	0.120	0.122
E	2.70	2.85	2.98	0.106	0.112	0.117
E <sub>1</sub>	1.55	1.65	1.70	0.061	0.065	0.067
e	0.95 BSC			0.0374 BSC		
e <sub>1</sub>	1.80	1.90	2.00	0.071	0.075	0.079
L	0.32	-	0.50	0.012	-	0.020
L <sub>1</sub>	0.60 Ref			0.024 Ref		
L <sub>2</sub>	0.25 BSC			0.010 BSC		
R	0.10	-	-	0.004	-	-
θ	0°	4°	8°	0°	4°	8°
θ <sub>1</sub>	7° Nom			7° Nom		
ECN: C-06593-Rev. I, 18-Dec-06						
DWG: 5540						

## Recommended Land Pattern For TSOP-5L / TSOP-6L


**Note**

- All dimensions are in inches (millimeter)

ECN: C22-0860-Rev. B, 24-Oct-2022  
DWG: 3010





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